

ightarrow ightarrow ightarrow Inductors (Coils) ightarrow Detailed Information

Inductors (Coils)

Product Top Pa	ge Search by Part No.	Search by Characteristics	Cross Reference	Catalog	Tech Notes	▼ more
MHQ04	02P1N6CT	000				Image: State of the state o
Applications	Commercial Gra	de				PDF file of this page
Feature	Multilayer Multilayer Non-Mag Core Non-Magnetic Core (Dielectric Ceramic) Super High Q Super High Q			о • • • • • • • • •		Contact
Series Type	ries Type MHQ-P					Documents
Status	Production (Not Recommended for New Design) Recommended Alternate Part No. : <u>MHQ0402PSA1N6CT000</u> (Interc hangeability is not guaranteed.)		and	Images are for reference only and show exemplary products.	Catalog Catalog RoHS Certificate SVHC/REACH Certificate	
Brand	TDK					Product Lineup
						[Selection Guide] Inductors for high frequency applications Update
Size						Sample Kits
Length(L)		0.44mm ±0.0	2mm			Technical Support Tools
Width(W)			0.24mm ±0.02mm			S-parameter
Thickness Hei	aht	0.24mm ±0.0				SPICE Netlist (Simple)
•	Land Pattern (A)		0.15mm to 0.20mm			SPICE Netlist (Precision)
Recommended Land Pattern (B)		0.20mm Non				Equivalent Circuit Model
Recommended Land Pattern (C)		0.18mm to 0	0.18mm to 0.20mm			
Electrical Char	racteristics					
Inductance		1.6nH ±0.2nl	1.6nH ±0.2nH at 500MHz			
Rated Current		320mA	320mA			
DC Resistance [Typ.]		140mΩ				
DC Resistance	[Max.]	300mΩ				
Self Resonant Frequency [Min.]		8GHz	8GHz			
Self Resonant Frequency [Typ.]		11.1GHz	11.1GHz			
Q [Min.]		10 at 500MH	10 at 500MHz			
Q [Тур.]		14 at 500MH	14 at 500MHz			
Other						
Operating Temp	o. Range (Including Self-T	emp. Rise) -55 to 125°C				
Soldering Method Reflow						
AEC-Q200 No						
Packing Punched (Paper)Taping [180		per)Taping [180mm	Reel]			
Package Quantity 20000pcs						
-	Weight 0.00011g					

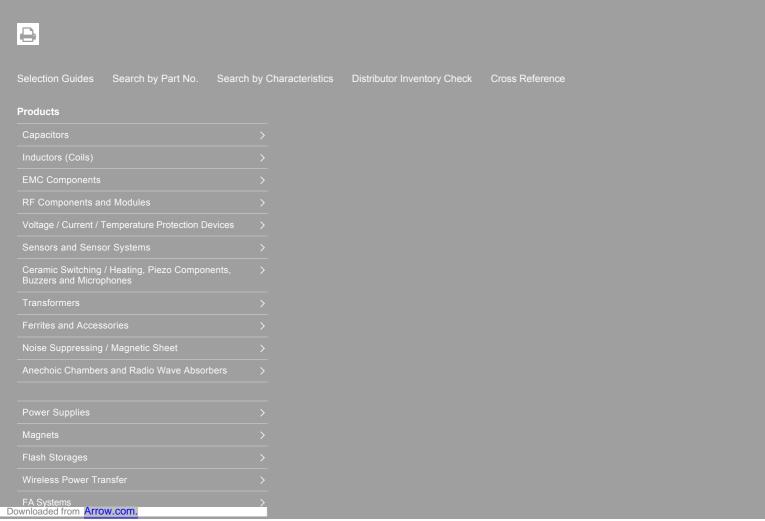
Rac

characteristics.)

Downloaded from Arrow.com.

Impedance

MHQ0402P1N6CT000	MHQ0402P1N6CT000
Change settings	Change settings
Inductance	Q
MHQ0402P1N6CT000	MHQ0402P1N6CT000
Change settings	Change settings



Transparent Conductive Film	>	
Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)		
Solar Cells		
Biosensor		
Application Specific IC (ASIC) Development and Supply		
Application Guides		
Technical Support		
Tech Library		
Environment		
Contact		
News		
Home		
About TDK		
TDK Worldwide		
Terms of Use Privacy Policy Cookie Policy		Copyright(c) 2019 TDK Corporation. All rights reserved. TDK logo is a trademark or registered trademark of TDK Corporation.